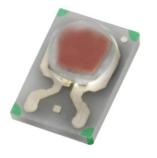
DATASHEET

EAHP3045YA2

Introduction

The EAHP3045 series is a surface-mount high-power device featuring high brightness combined with a compact size that is suitable for all kinds of lighting applications such as



general illumination, flash, spot, signal, industrial and commercial lighting. The thermal pad of this device is electrically isolated providing convenience in thermal and electrical design. The EAHP3045 series is one of the most promising devices in Everlight's high power product offering and is ready to face the challenges of today's Solid-State Lighting requirements.

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Features

- LM-80 Certified
- Small package with high efficiency
- ESD protection up to 8KV
- Soldering method: SMT
- Binning Parameters: Brightness,
 Forward Voltage ,Wavelength and
 Chromaticity
- Moisture Sensitivity Level: 1
- RoHS compliant
- Matches ANSI binning

Applications

- General Lighting
- Decorative and Entertainment
 Lighting
- Signal and Symbol Luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- Exterior and Interior Automotive Illumination
- Agriculture Lighting

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Max. DC Forward Current (mA)	I _F	750 _[1]	mA
Max. Peak Pulse Current (mA)	I _{Pulse}	1000[2]	mA
Max. ESD Resistance	V _B	8000	V
Reverse Voltage	V _R	Note 3	V
Thermal Resistance	R _{th}	6~8 _[4]	°C/W
Max. Junction Temperature	TJ	125 _[5]	°C
Operating Temperature	T _{Opr}	-40 ~ +100 _[6]	°C
Storage Temperature	T _{Stg}	-40 ~ +100	°C
Max. Soldering Temperature	T _{Sol}	260	°C
Max. Allowable Reflow Cycles	n/a	2	cycles

Notes:

- 1. Maximum forward current for 3W is 750mA (Thermal Pad=25°C).
- 2. Duty cycle = 1/10@1KHZ
- 3. The EAHP3045 series LEDs are not designed for reverse bias use.
- 4. Thermal Resistance is 10°C/W for Blue, Green, Cool-White, Neutral-White, and Warm-White LEDs and 12°C/W for Red, Amber, and Orange LEDs.
- 5. Maximum junction temperature of Cool-White, Neutral-White, Warm-White, Blue, Green, Red, Amber, and Orange LEDs is 125°C.
- 6. Maximum Operating Temperature (Thermal Pad) of Cool-White, Neutral-White, Warm-White, Blue, Green, Red, Amber, and Orange LEDs is 100°C.

JEDEC Moisture Sensitivity

Level		Floor Life		luirements ndard
	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≦30°C / 85% RH	168 (+5/-0)	85°C / 85% RH

PN of the EAHP3045 series: Color LEDs

Color	Order Code	Minimum Luminous Flux (Im)	Wavelength (nm)	Forward Voltage(V)
Amber	EAHP3045YA2	90	585~592.5	2.05~3.25

Note:

Each 3W direct color PN is based on the min. bin and includes four adjacent bins.

Product Binning

Group	Bin	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)
	1	4	5
	2	5	6
	3	6	8
	4	8	10
E	5	10	13
	6	13	17
	7	17	20
	8	20	23
	9	23	27
	1	27	33
	2	33	39
	3	39	45
	4	45	52
F	5	52	60
	6	60	70
	7	70	80
	8	80	90
	9	90	100

Luminous Flux Bins

GroupBinMinimum Photometric Flux (lm)Maximum Photometric Flux (lm)110011021101203120130413014051401506150160716018081802009200225225027532753004300325532535063503757375400840042594254501450475247550035005254525550						
2 110 120 3 120 130 4 130 140 5 140 150 6 150 160 7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 3 275 300 4 300 325 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525	Group	Bin	Photometric	Photometric		
3 120 130 4 130 140 5 140 150 6 150 160 7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 3 275 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		1	100	110		
4 130 140 5 140 150 6 150 160 7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		2	110	120		
J 5 140 150 6 150 160 7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		3	120	130		
6 150 160 7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		4	130	140		
7 160 180 8 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525	J	5	140	150		
N 180 200 9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		6	150	160		
9 200 225 1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		7	160	180		
1 225 250 2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		8	180	200		
2 250 275 3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		9	200	225		
3 275 300 4 300 325 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		1	225	250		
4 300 325 K 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		2	250	275		
K 5 325 350 6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		3	275	300		
6 350 375 7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		4	300	325		
7 375 400 8 400 425 9 425 450 1 450 475 2 475 500 3 500 525	К	5	325	350		
8 400 425 9 425 450 1 450 475 2 475 500 3 500 525		6	350	375		
9 425 450 1 450 475 2 475 500 3 500 525		7	375	400		
N 1 450 475 2 475 500 3 500 525		8	400	425		
N 2 475 500 3 500 525		9	425	450		
N <u>3 500 525</u>		1	450	475		
3 500 525	NI	2	475	500		
4 525 550	IN	3	500	525		
		4	525	550		

Radiometric Power Bins

Group	Bin	Minimum Radiometric Power(mW)	Maximum Radiometric Power(mW)
	1	0	25
	2	25	50
	3	50	75
	4	75	100
Q	5	100	125
	6	125	175
	7	175	225
	8	225	275
	9	275	350

ower Dills					
Group	Minimum Bin Radiometric Power(mW)		Maximum Radiometric Power(mW)		
	1	350	425		
	2	425	500		
	3	500	600		
	4	600	700		
R	5	700	800		
	6	800	900		
	7	900	1000		
	8	1000	1300		
	9	1300	1600		

Forward Voltage Bins

Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
U1	1.75	2.05
U2	2.05	2.35
U3	2.35	2.65
U4	2.65	2.95
V1	2.95	3.25
V2	3.25	3.55
V3	3.55	3.85
V4	3.85	4.15

Notes:

1. Forward voltage measurement tolerance: ±0.1V.

2.

Forward voltage bins are defined at $I_{F}=350$ mA operation. Other Forward Voltage bins for White LEDs available upon request. Please contact your local Everlight sales 3. office.

Color Bins

		Minimum Dominant	Maximum Dominant
Group Bin			
		Wavelength (nm)	Wavelength (nm)
	1	430	435
	2	435	440
	3	440	445
B	4	445	450
(Blue)	5	450	455
	6	455	460
	7	460	465
	8	465	470
	1	520	525
	2	525	530
G	3	530	535
(Green)	4	535	540
	5	540	545
	6	545	550
	1	580	582.5
	2	582.5	585
Α	3	585	587.5
(Amber)	4	587.5	590
	5	590	592.5
	6	592.5	595
	3	610	615
R	4	615	620
(Red)	5	620	625
	6	625	630
	1	635	640
	2	640	645
	3	645	650
D	4	650	655
(Deep-Red)	5	655	660
	6	660	665
	7	665	670
	8	670	675
	1	700	710
	2	710	715
	3	715	720
F	4	720	725
(Far-Red)	5	725	730
	6	730	735
	7	735	740
	8	740	745

Notes:

- 1. Dominant / Peak wavelength measurement tolerance: ±1nm.
- 2. Dominant / Peak wavelength bins are defined at I_F=350 mA operation.
- 3. The range of wavelength in Royal-Blue, Deep-Red and Far-Red is described as peak-wavelength.

Optical Characteristics

Color	Pea	minant Wavelengthλ _D Peak Wavelengthλ _P Ior Temperature CCT		Typical Temperature Coefficient of Dominant Wavelength (nm/°C)-(△λ _D /△	Typical Viewing Angle (degrees) 2θ _{1/2}
	Min.	Тур.	Max.	T _J)	
Cool-White	4745K	5700K	7050K		Note 5
Neutral-White	3710K	4260K	4745K		Note 5
Warm-White	2580K	3000K	3710K		Note 5
Red	620nm		630nm	0.05	120
Orange	610nm		620nm	0.08	120
Amber	585nm		595nm	0.1	120
Green	520nm		535nm	0.05	120
Blue	460nm		470nm	0.05	120
Deep-Red	645nm		675nm	0.08	120
Far-Red	715nm		745nm	0.04	120

Notes:

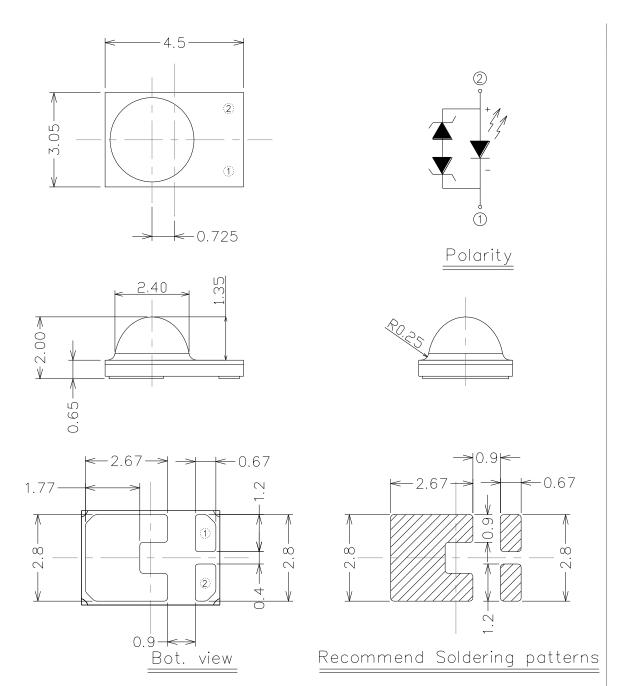
1. The test tolerance of Everlight is ±0.5nm for dominant wavelength, ±5% for CCT.

2. Viewing angle is the width of half the light output intensity in all directions of 180°.

3. All Cool-White, Neutral-White, Warm-White, and dominant wavelength below 550nm LEDs are made with Indium Gallium Nitride (InGaN).

4. All LEDs with dominant wavelength exceeding 550nm are made with Aluminum Indium Gallium Phosphide (AllnGaP).

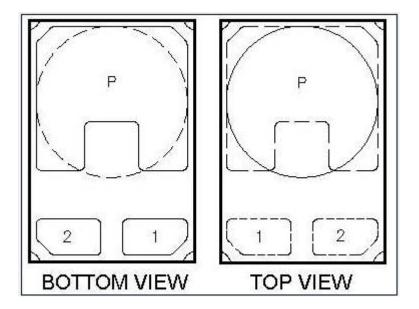
Mechanical Dimension



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ± 0.15mm.
- 3. The thermal pad is electrically isolated from the Anode and Cathode contact pads.
- 4. Do not handle the device by the lens. Incorrect force applied to the lens may lead to the failure of devices.

Pad Configuration

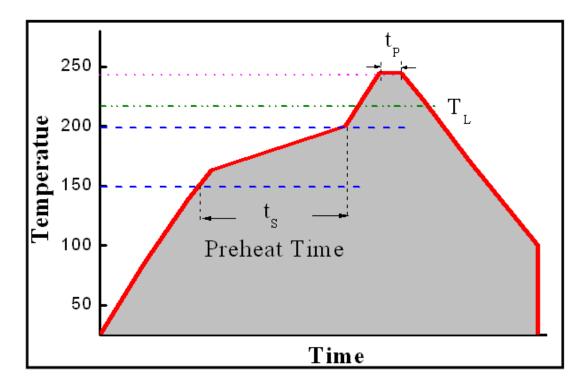


PAD	FUNCTION
1	CATHODE
2	ANODE
Р	THERMAL PAD

Reflow Soldering Characteristics

For Reflow Process

- a. EAHP3045 series are suitable for SMT processes.
- b. Curing of glue in oven must be according to standard operation flow processes.



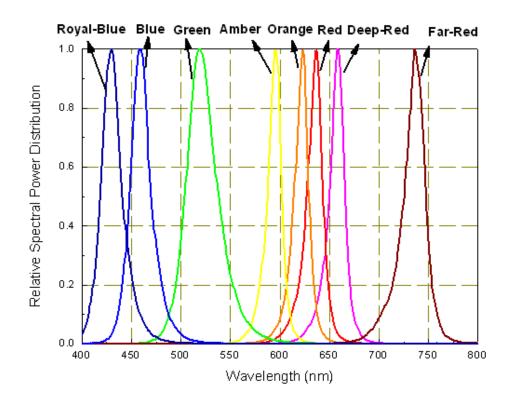
Profile Feature	Lead Free Assembly
Ramp-Up Rate	2-3 °C/S
Preheat Temperature	150-200 ℃
Preheat Time (t _s)	60-120 S
Liquid Temperature (T _L)	217 °C
Time maintained above ${\sf T}_{\sf L}$	60-90 S
Peak Temperature (T _P)	240±5 ℃
Peak Time (t _P)	Max 20 S
Ramp-Down Rate	3-5 ℃/S

c. Reflow soldering should not be done more than twice.

- d. In soldering process, stress on the LEDs during heating should be avoided.
- e. After soldering, do not bend the circuit board.

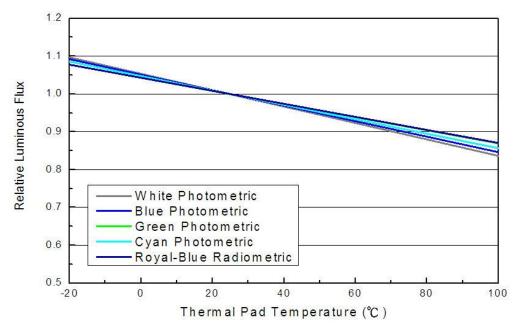
Wavelength Characteristics

For Deep-Red, Red, Amber, Yellow, Green, Cyan, Blue, Royal-Blue @ Thermal Pad Temperature = 25° C

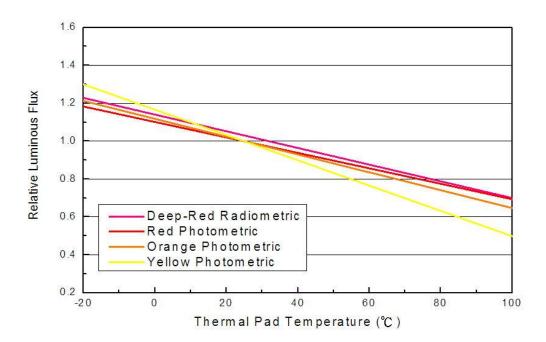


Typical Light Output Characteristic V.S. Thermal Pad Temperature

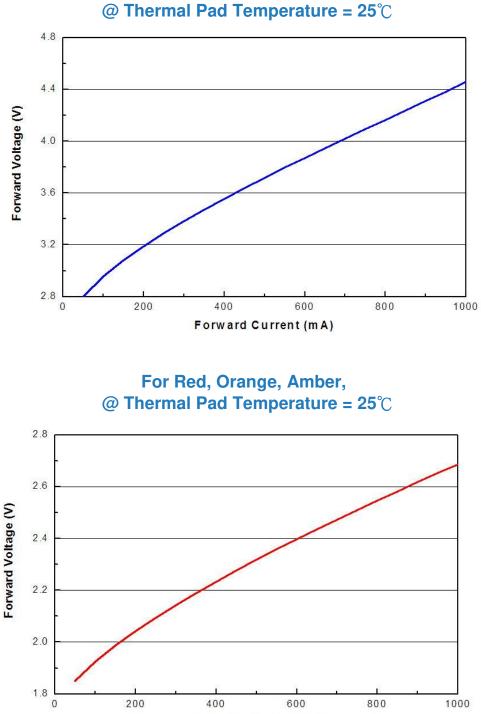
Cool-White, Neutral-White, Warm-White, Green, Cyan, Blue, Royal-Blue for 350mA Drive Current







Typical Electrical Characteristics

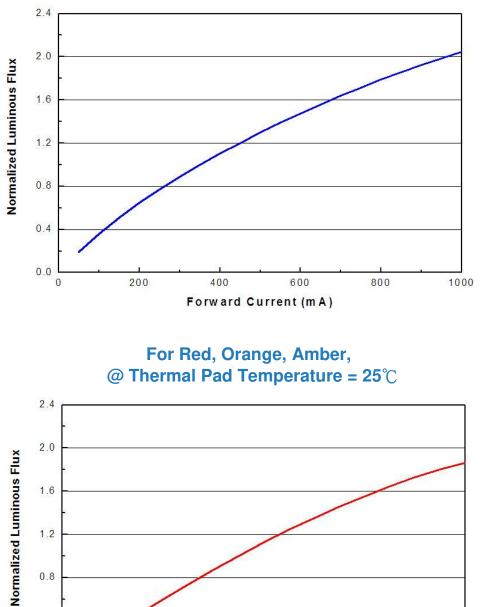


Forward Current (mA)

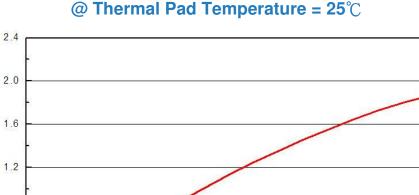
EVERLIGH

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Typical Relative Luminous Flux V.S. Forward Current



For Green, Blue, @ Thermal Pad Temperature = 25°C



400

Forward Current (mA)

600

800

200

0.8

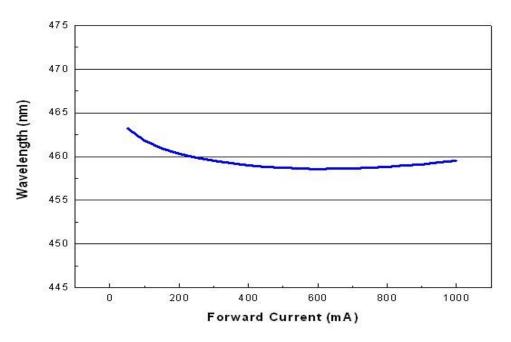
0.4

0.0

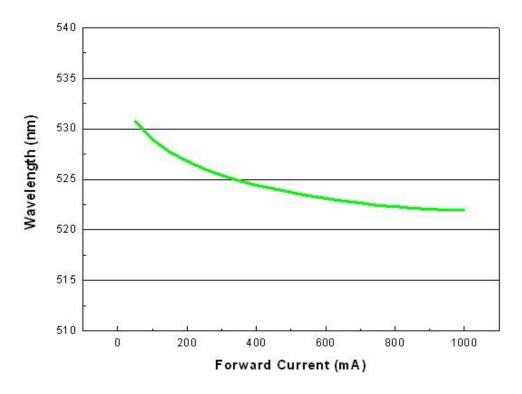
0

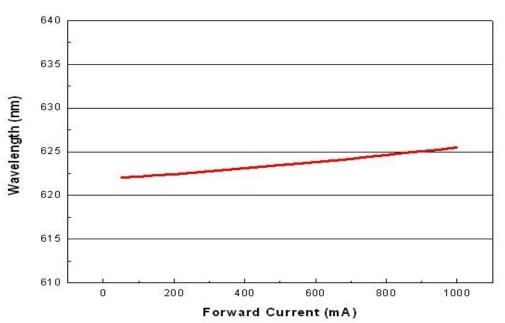
Typical Wavelength Shift Characteristics V.S. Forward Current

For Blue @ Thermal Pad Temperature = 25°C



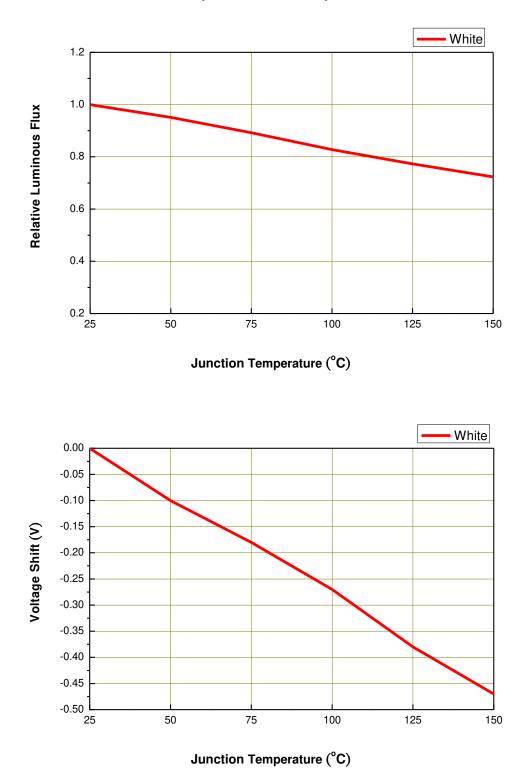
For Green @ Thermal Pad Temperature = 25°C





For Red @ Thermal Pad Temperature = 25℃

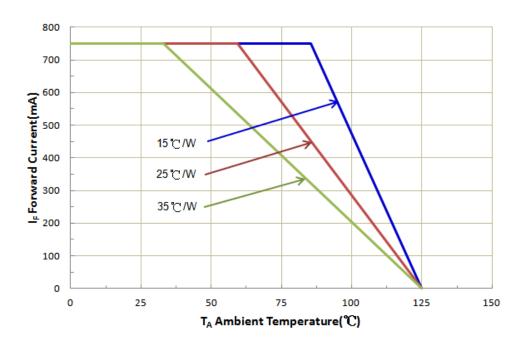
Relative Flux and Forward Voltage V.S. Junction Temperature (IF = 700 mA)





Current Derating Curves

Current Derating Curve for 75mA Drive Current Cool-White, Neutral-White, Warm-White, Green, Cyan, Blue, Royal-Blue, Far-Red, Deep-Red, Red, Amber, Yellow

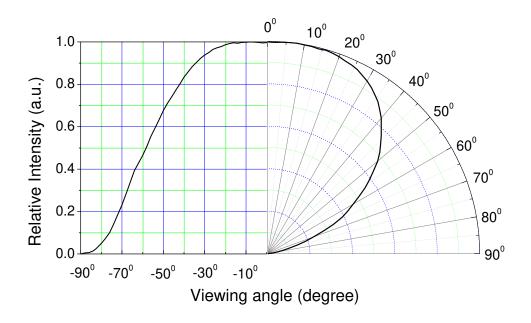


Note:

The current derating curves are depending on the thermal resistance between the junction to the soldering pad.

Typical Radiation Patterns

Typical Diagram Characteristics of Radiation for Cool-White, Neutral-White, Warm-White



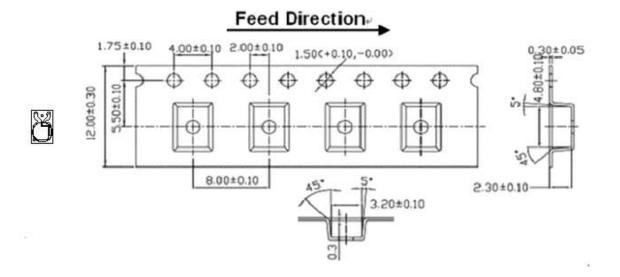
Notes:

- 1. 20_{1/2} is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is $\pm 5^{\circ}$.

Emitter Tape Packaging

Carrier Tape Dimensions as the following:

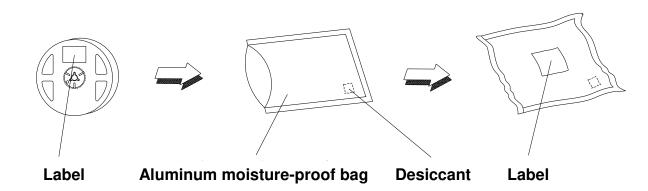
Reel: 400pcs, MOQ > 2Kpcs(has to be a multiple of 400pcs)



Notes:

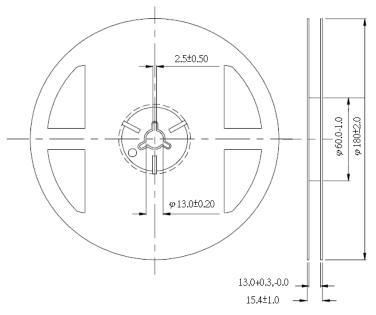
- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ±0.1mm.

Moisture Resistant Packaging



Emitter Reel Packaging

Reel Dimensions



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ±0.1mm.

Product Labeling

Label Explanation

- CPN: Customer Specification (when required)
- P/N : Everlight Production Number
- QTY: Packing Quantity
- CAT: Luminous Flux (Brightness) Bin
- HUE: Color Bin
- REF: Forward Voltage Bin
- LOT No: Lot Number
- MADE IN TAIWAN: Production Place



Storage Conditions

- Before the package is opened. The LEDs should be stored at 30°C or less and 85%RH or less after being shipped from Everlight and the storage life limits are 1 year. The LEDs can be stored up to 3 years If in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- After opening the package: The LED's floor life is 1 year under 30°C or less and 60%RH or less. The LED should be soldered with 168hrs (7days) after opening the package. If unused LEDs remain, it should be stored in moisture proof packages.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.



Revision History

Current version: 2014/07/03 Device No: DHE-000XXXX Version. 1

Page	Subjects (major change in previous version)	Date of change